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### BC237/238/239

# Switching and Amplifier Applications • Low Noise: BC239



# **NPN Epitaxial Silicon Transistor**

1. Collector 2. Base 3. Emitter

### **Absolute Maximum Ratings** $T_a=25$ °C unless otherwise noted

Symbol	Parame	ter	Value	Units
V <sub>CES</sub>	Collector-Emitter Voltage	: BC237 : BC238/239	50 30	V V
V <sub>CEO</sub>	Collector-Emitter Voltage	: BC237 : BC238/239	45 25	V V
V <sub>EBO</sub>	Emitter-Base Voltage	: BC237 : BC238/239	6 5	V V
I <sub>C</sub>	Collector Current (DC)		100	mA
P <sub>C</sub>	Collector Power Dissipation		500	mW
T <sub>J</sub>	Junction Temperature		150	°C
T <sub>STG</sub>	Storage Temperature		-55 ~ 150	°C

## $\textbf{Electrical Characteristics} \ \, \textbf{T}_{\textbf{a}} = 25 ^{\circ} \textbf{C} \ \, \textbf{unless otherwise noted}$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage : BC237 : BC238/239	I <sub>C</sub> =2mA, I <sub>B</sub> =0	45 25			V V
BV <sub>EBO</sub>	Emitter Base Breakdown Voltage : BC237 : BC238/239	I <sub>E</sub> =1μA, I <sub>C</sub> =0	6 5			V V
I <sub>CES</sub>	Collector Cut-off Current : BC237 : BC238/239	V <sub>CE</sub> =50V, V <sub>BE</sub> =0 V <sub>CE</sub> =30V, V <sub>BE</sub> =0		0.2 0.2	15 15	nA nA
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> =5V, I <sub>C</sub> =2mA	120		800	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0.5mA I <sub>C</sub> =100mA, I <sub>B</sub> =5mA		0.07 0.2	0.2 0.6	V
V <sub>BE</sub> (sat)	Collector-Base Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =0.5mA I <sub>C</sub> =100mA, I <sub>B</sub> =5mA		0.73 0.87	0.83 1.05	V V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	V <sub>CE</sub> =5V, I <sub>C</sub> =2mA	0.55	0.62	0.7	V
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE}$ =3V, $I_{C}$ =0.5mA, f=100MHz $V_{CE}$ =5V, $I_{C}$ =10mA, f=100MHz	150	85 250		MHz MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz		3.5	6	pF
C <sub>ib</sub>	Input Base Capacitance	V <sub>EB</sub> =0.5V, I <sub>C</sub> =0, f=1MHz		8		pF
NF	Noise Figure : BC237/238 : BC239 : BC239	$\begin{array}{c} \text{V}_{\text{CE}}\text{=}5\text{V, I}_{\text{C}}\text{=}0.2\text{mA,} \\ \text{f=}1\text{KHz R}_{\text{G}}\text{=}2\text{K}\Omega \\ \text{V}_{\text{CE}}\text{=}5\text{V, I}_{\text{C}}\text{=}0.2\text{mA} \\ \text{R}_{\text{G}}\text{=}2\text{K}\Omega, \text{f=}30\text{$^{-}$15\text{KHz}} \end{array}$		2	10 4 4	dB dB dB

## **h**<sub>FE</sub> Classification

Classification	Α	В	С	
h <sub>FE</sub>	120 ~ 220	180 ~ 460	380 ~ 800	

# **Typical Characteristics**

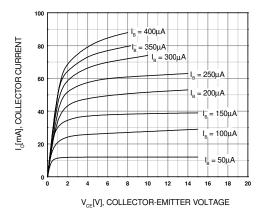
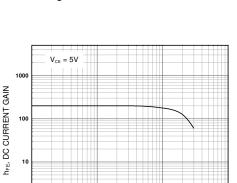


Figure 1. Static Characteristic



I<sub>C</sub>[mA], COLLECTOR CURRENT

Figure 3. DC current Gain

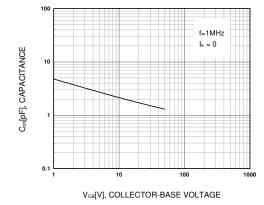


Figure 5. Output Capacitance

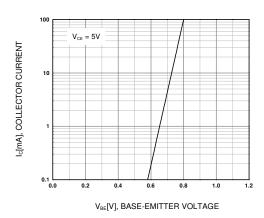


Figure 2. Transfer Characteristic

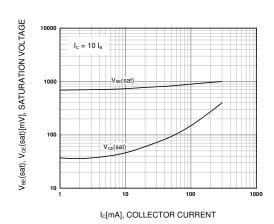
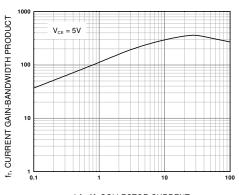


Figure 4. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

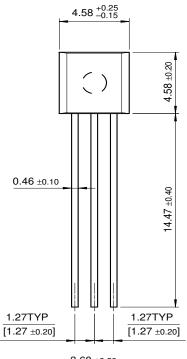


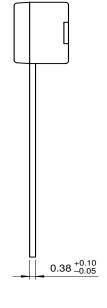
 $I_{\text{C}}[\text{mA}],$  COLLECTOR CURRENT

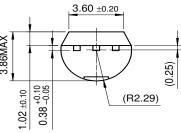
Figure 6. Current Gain Bandwidth Product

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E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	I <sup>2</sup> C™	OCX™	RapidConfigure™	UHC™
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The Power Franchise™		OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
Programmable Ad	ctive Droop™	OPTOPLANAR™	SMART START™	

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Rev. I1

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